

General-purpose Operational Amplifiers / Comparators

NOW SERIES Operational Amplifiers



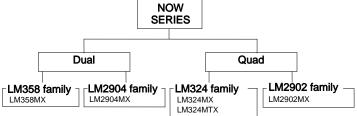


LM358MX,LM2904MX,LM324MX,LM324MTX,LM2902MX

No.11094ECT01

Description

The Universal Standard family LM358 / 324, LM2904 / 2902 monolithic ICs integrate two independent op-amps and phase compensation capacitors on a single chip and feature high-gain, low power consumption, and an operating voltage range of 3[V] to 32[V] (single power supply.)



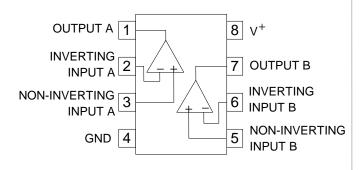
Features

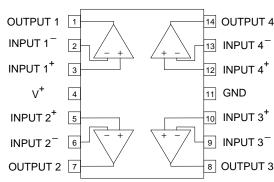
1) Operating temperature range

Commercial Grade LM358 / 324 family : $0[^{\circ}C] \text{ to } + 70[^{\circ}C]$ Extended Industrial Grade LM2904 / 2902 family : $-40[^{\circ}C] \text{ to } +85[^{\circ}C]$

- 2) Wide operating supply voltage +3[V] to +32[V] (single supply) ±1.5[V] to ±16[V] (dual supply)
- 3) Low supply current
- 4) Common-mode input voltage range including ground
- 5) Differential input voltage range equal to maximum rated
- 5) Supply voltage
- 6) High large signal voltage gain
- 7) Wide output voltage range

●Pin Assignment





SO package8

LM358MX LM2904MX SO package14

LM324MX LM2902MX TSSOP14

LM324MTX

● Absolute Maximum Ratings (Ta=25[°C])

Parameter	Cumbal	Ratings									
Parameter	Symbol	LM358 family LM324 family LM2904 family		58 family LM324 family LM2904 family LM2902 fa		Unit					
Supply Voltage	V ⁺	+:	32	+:	V						
Operating Temperature Range	Topr	0 to	+70	-40 to	0 +85	°C					
Storage Temperature Range	Tstg	-65 to +150						-65 to +150			°C
Storage Temperature Range	VICM	-0.3 t	o +32	o +26	V						
Maximum junction Temperature	Tjmax	+150									

Electric Characteristics

OLM358,LM324 family (Unless otherwise specified, V⁺=+5[V])

			Limits									
Parameter	Symbol	Temperature range	LN	//358 fan	nily	LN	//324 fan	nily	Unit	Conditions	Fig. No	
			Min.	Тур.	Max.	Min.	Тур.	Max.				
Input Offset Voltage (*1)	VIO	25°C	_	2	7	_	2	7	mV	RS=0[Ω] VO=1.4[V]	98	
input Onset voltage (1)	VIO	Full range	_	_	9	_	_	9	IIIV	V ⁺ =5[V] to 30[V]	30	
Input Offset Voltage Drift	αVIO	_	_	7	_	_	7	_	μV/°C	RS=0[Ω]	_	
1		25°C	_	45	250	_	45	250		VO=1.4[V]		
Input Bias Current (*1)	IIB	Full range	-	40	500	_	40	500	nA	IIN (+)orIIN(-) VCM=0[V]	98	
Innut Officet Coursest (*4)	110	25°C	_	5	50	_	5	50		IIN (+)-IIN (-),VCM=0[V]	00	
Input Offset Current (*1)	IIO	Full range	_	_	150	_	_	150	nA	IIN (+)-IIN (-)	98	
Input Offset Current Drift	αΙΙΟ	_	_	10	_	_	10	_	pA/°C	RS=0[Ω]	_	
Innut Common made Valtage Dange	VICR	25°C	_	_	V ⁺ -1.5	_	_	V ⁺ -1.5	V	\/ ⁺ 20[\/] (*0)	98	
Input Common-mode Voltage Range	VICK	Full range	_	_	V*-2.0	_	_	V*-2.0	V	V ⁺ =30[V] (*8)	98	
			_	0.5	1.2	_	0.7	1.2	mA	V ⁺ =5[V] RL=∞ All Op Amps	99	
Supply Current	ICC	Full range	_	1	2	_	1.5	3		V ⁺ =30[V] RL=∞ All Op Amps		
0	VOH		27	28	-	27	28	_	V	V ⁺ =30[V],RL=10[kΩ]	99	
Output Voltage Swing	VOL	Full range	-	5	20	_	5	20	mV	RL=10[kΩ], V ⁺ =5[V]	99	
Large Signal Voltage Gain	AV	25°C	25	100	_	25	100	_	V/mV	V^+ =15[V] VO=1[V] to 11[V] RL≥2[kΩ]	98	
Common-mode Rejection ratio	CMRR	25°C	65	85	_	65	85	_	dB	VCM=0[V] to V ⁺ -1.5[V]	98	
Power Supply Rejection Ratio	PSRR	25°C	65	100	1	65	100	_	dB	V ⁺ =5[V] to 30[V]	98	
Amplifier-to-Amplifier Coupling	VO1/VO2	25°C	-	120	_	-	120	_	dB	f=1[kHz] to 20[kHz] input referred	101	
		25°C	20	40	_	20	40	_		V ⁺ =15[V],VO=2[V]		
	Source	Full range	10	20	_	10	20	_	mA	VIN+=1[V],VIN-=0[V]		
Output Current (*2)		25°C	10	20	_	10	20	_	mA		99	
	Sink	Full range	2	8	-	2	8	_		V ⁺ =15[V],VO=2[V] VIN+=0[V],VIN-=1[V]		
		Full range	12	50	_	12	40	_	μA	-[-],[-]		

^(*1) Absolute value

^(*2) Under high temperatures, please consider the power dissipation when selecting the output current.

When output terminal is continuously shorted the output current reduces the internal temperature by flushing.

OLM2904,LM2902 family (Unless otherwise specified, V⁺=+5[V])

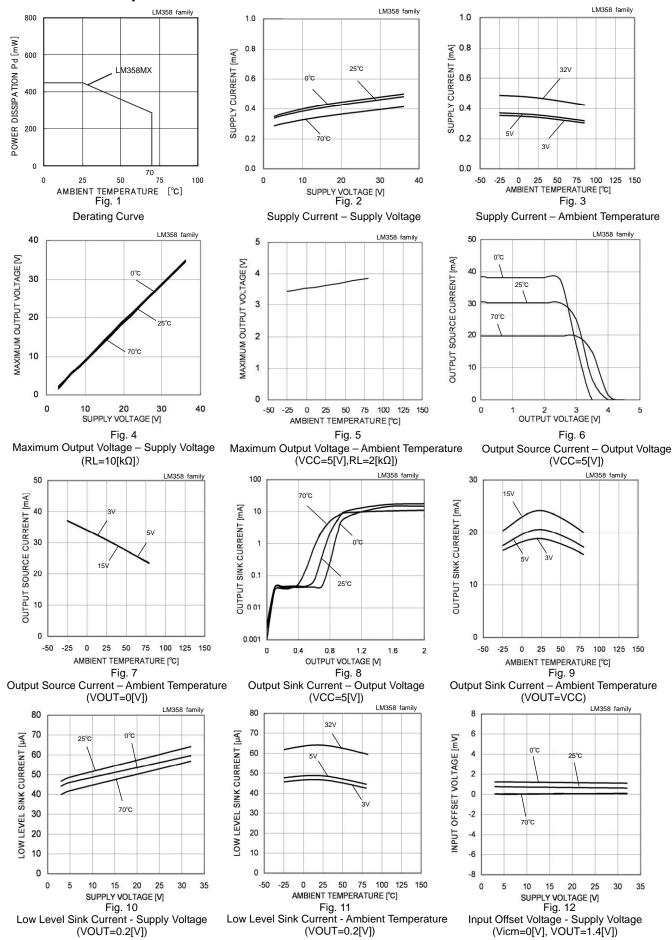
					Lin	nits						
Parameter	Unit	Temperature range	LM	12904 far	mily	LN	12902 far	mily	Unit	Conditions	Fig.No	
			Min.	Тур.	Max.	Min.	Тур.	Max.				
Input Offset Voltage (*3)	VIO	25°C	_	2	7	_	2	7	mV	RS=0[Ω] VO=1.4[V]	98	
input Offset Voltage (3)	VIO	Full range	_	_	10	_	_	10	mv	V ⁺ =5[V] to 26[V]	96	
Input Offset Voltage Drift	αVIO	_	-	7	_	-	7	_	μV/°C	RS=0[Ω]	-	
L (B) ((#0)	up.	25°C	_	45	250	_	45	250		VO=1.4[V]		
Input Bias Current (*3)	IIB	Full range	_	40	500	_	_	500	nA	IIN(+)orIIN(-) VCM=0[V]	98	
1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0		25°C	_	5	50	_	5	50		IIN(+)-IIN(-),VCM=0[V]	-00	
Input Offset Current (*3)	IIO	Full range	_	45	200	_	45	200	nA	IIN(+)-IIN(-)	98	
Input Offset Current Drift	αΙΙΟ	_	_	10	_	-	10	_	pA/°C	RS=0[Ω]	-	
1 O	\#0D	25°C	_	-	V ⁺ -1.5	_	-	V ⁺ -1.5	.,	\	-00	
Input Common-mode Voltage Range	VICR	Full range	_	_	V*-2.0	-	_	V*-2.0	V	V ⁺ =26[V] (*8)	98	
			_	0.5	1.2	_	0.7	1.2		V ⁺ =5[V] RL=∞ All Op Amps		
Supply Current	ICC	Full range	_	1	2	_	1.5	3	mA	V ⁺ =26[V], RL=∞ All Op Amps	99	
Output Voltage Swing	VOH		23	24	_	23	24	_	V	$V^{+}=26[V], RL=10[k\Omega]$	1	
Output voltage Swing	VOL	Full range	_	5	100	_	5	100	mV	RL=10[kΩ], V ⁺ =5[V]	99	
Large Signal Voltage Gain	AV	25°C	25	100	_	25	100	_	V/mV	V^{+} =15[V] VO=1[V] to 11[V] RL≧2[kΩ]	98	
Common-mode Rejection Ratio	CMRR	25°C	50	70	_	50	70	_	dB	VCM=0[V]to V ⁺ =-1.5[V]	98	
Power Supply Rejection Ratio	PSRR	25°C	50	100	_	50	100	_	dB	V ⁺ =5[V] to 26[V]	98	
Amplifier-to-Amplifier Coupling	VO1/VO2	25°C	_	120	_	-	120	_	dB	f=1[kHz] to 20[kHz] Input referred	101	
		25°C	20	40	_	20	40	_		V ⁺ =15[V], VO=2[V]		
	Source	Full range	10	20	_	10	20	_	mA	VIN+=1[V], VIN-=0[V]		
Output Current (*4)		25°C	10	20	_	10	20	_	^		99	
	Sink	Full range	2	8	_	2	8	_	mA	V ⁺ =15[V], VO=2[V] VIN+=0[V], VIN-=1[V]		
		Full range	12	50	_	12	50	_	μA			

^(*3) Absolute value

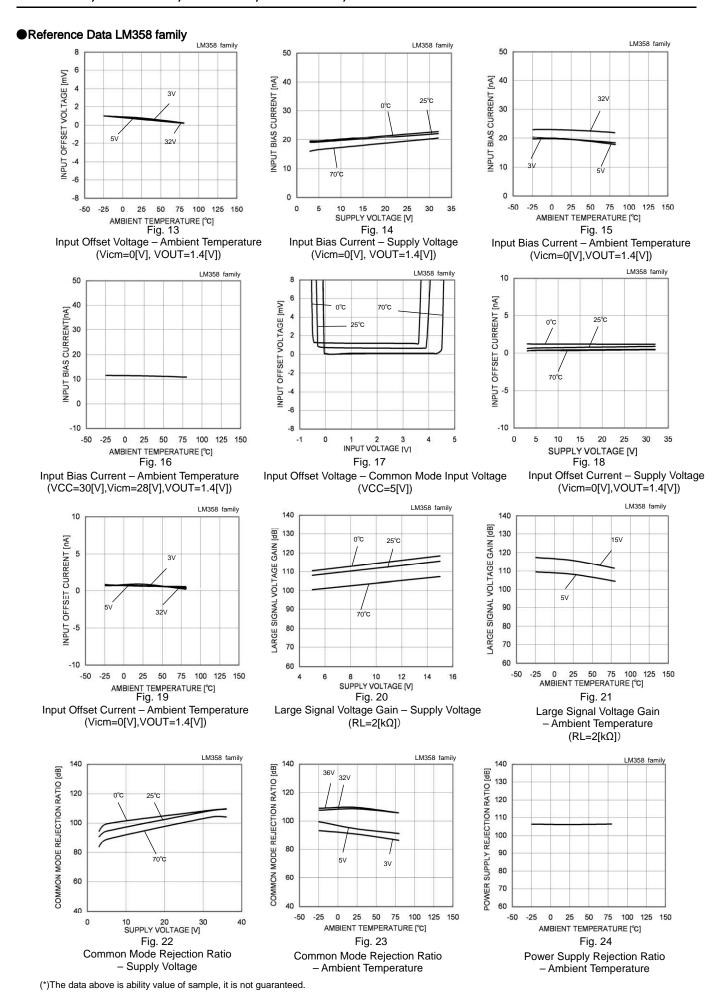
^(*4) Under high temperatures, please consider the power dissipation when selecting the output current.

When the output terminal is continuously shorted the output current reduces the internal temperature by flushing.

● Reference Data LM358 family

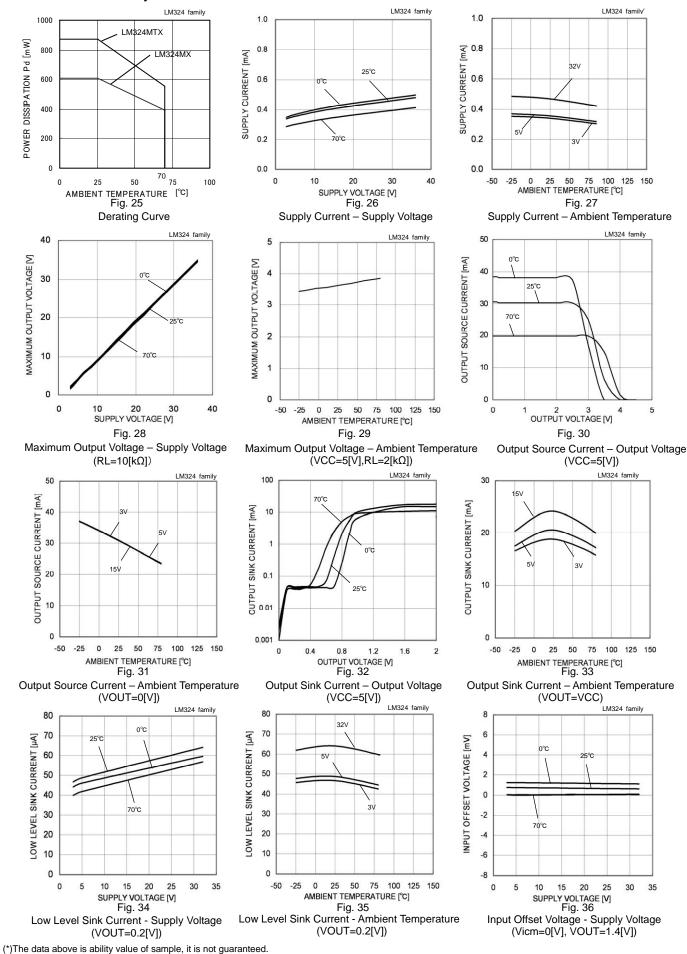


(*) The data above is ability value of sample, it is not guaranteed.



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● Reference Data LM324 family



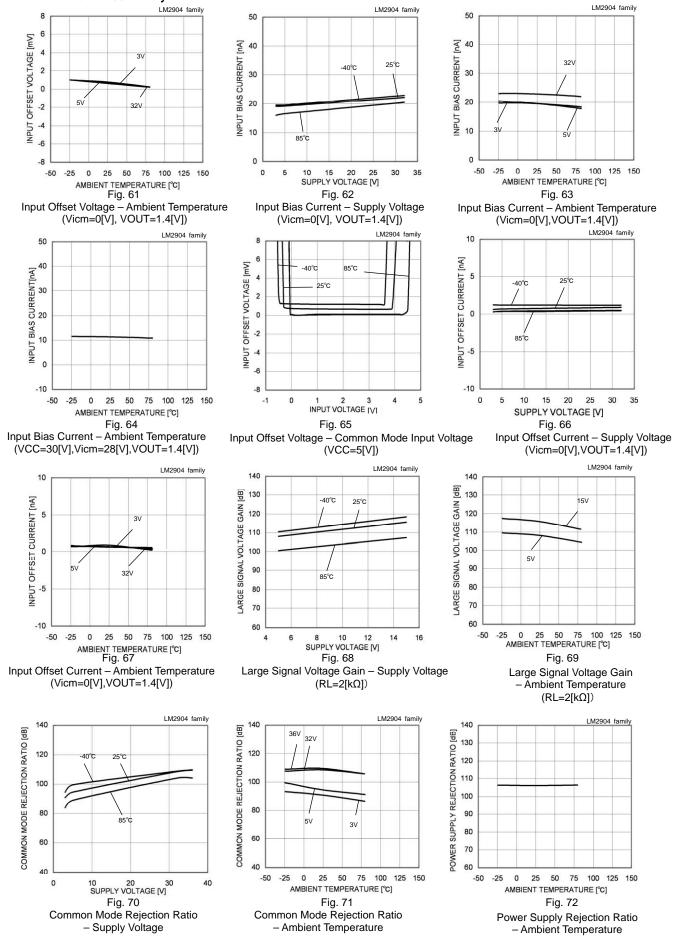
● Reference Data LM324 family LM324 family LM324 family LM324 family 50 50 INPUT OFFSET VOLTAGE [mV] INPUT BIAS CURRENT [nA] INPUT BIAS CURRENT [nA] 40 4 3V 32V 0°C 2 30 30 0 20 -2 10 10 10 15 20 25 SUPPLY VOLTAGE [V] 75 5 30 35 -25 0 0 -50 25 50 75 100 125 150 AMBIENT TEMPERATURE [°C] AMBIENT TEMPERATURE [°C] Fig. 38 Input Bias Current – Supply Voltage Fig. 37 Fig. 39 Input Offset Voltage – Ambient Temperature Input Bias Current - Ambient Temperature (Vicm=0[V], VOUT=1.4[V]) (Vicm=0[V], VOUT=1.4[V]) (Vicm=0[V], VOUT=1.4[V]) LM324 family INPUT OFFSET CURRENT [nA] 40 INPUT OFFSET VOLTAGE [mV] INPUT BIAS CURRENT[nA] 70°C 25°0 0°C 25°C 2 0 -2 70°C 0 -6 -10 -10 0 5 -25 75 100 125 150 0 15 20 25 30 35 -50 0 25 50 1 2 3 INPUT VOLTAGE [V] 10 SUPPLY VOLTAGE [V] AMBIENT TEMPERATURE [°C] Fig. 40 Fig. 41 Fig. 42 Input Bias Current – Ambient Temperature (VCC=30[V],Vicm=28[V],VOUT=1.4[V]) Input Offset Voltage Input Offset Current - Supply Voltage (Vicm=0[V],VOUT=1.4[V]) - Common Mode Input Voltage (VCC=5[V]) LM324 family LM324 family 140 140 10 130 130 INPUT OFFSET CURRENT [nA] 25°C LARGE SIGNAL VOLTAGE GAIN VOLTAGE GAIN 120 120 110 110 100 100 5V LARGE SIGNAL 90 90 321 70°C 80 80 70 70 60 -25 0 25 50 75 100 125 AMBIENT TEMPERATURE [°C] -25 0 25 50 75 100 125 8 10 12 SUPPLY VOLTAGE [V] Fig. 44 -50 AMBIENT TEMPERATURE [°C] Fig. 43 Fig. 45 Input Offset Current - Ambient Temperature Large Signal Voltage Gain - Supply Voltage Large Signal Voltage Gain (Vicm=0[V], VOUT=1.4[V]) $(RL=2[k\Omega])$ - Ambient Temperature $(RL=2[k\dot{\Omega}])$ LM324 family LM324 family 140 COMMON MODE REJECTION RATIO [dB] COMMON MODE REJECTION RATIO [dB] POWER SUPPLY REJECTION RATIO [dB] 130 120 120 120 110 100 100 100 80 80 90 70°C 80 60 60 70 40 25 50 75 100 125 0 25 50 75 100 125 150 0 10 20 30 SUPPLY VOLTAGE [V] AMBIENT TEMPERATURE [°C] AMBIENT TEMPERATURE [°C] Fig. 46 Fig. 47 Fig. 48 Common Mode Rejection Ratio Common Mode Rejection Ratio Power Supply Rejection Ratio Ambient Temperature Supply Voltage - Ambient Temperature

(*)The data above is ability value of sample, it is not guaranteed.

●Reference Data LM2904 family LM2904 family LM2904 family 1.0 1.0 POWER DISSIPATION Pd [mW] 0.8 0.8 SUPPLY CURRENT [mA] 600 SUPPLY CURRENT [mA] 25°C _M2904MX 32V 0.6 0.6 40°C 400 0.4 0.4 200 5V 0.2 0.2 0 0.0 0.0 50 75 100 0 25 50 75 100 125 150 AMBIENT TEMPERATURE [°C] 0 25 AMBIENT TEMPERATURE [°C] SUPPLY VOLTAGE [V] Fig.50 **Derating Curve** Supply Current - Supply Voltage Supply Current – Ambient Temperature LM2904 family LM2904 family LM2904 family 50 40 5 MAXIMUM OUTPUT VOLTAGE [V] OUTPUT SOURCE CURRENT [mA] MAXIMUM OUTPUT VOLTAGE [V] 40 -40°C 30 25°C 3 30 85°C 20 20 10 10 0 0 10 20 3 SUPPLY VOLTAGE [V] 0 -50 0 25 50 75 100 125 2 3 OUTPUT VOLTAGE [V] AMBIENT TEMPERATURE [°C] Fig. 54 Fig. 52 Fig. 53 Maximum Output Voltage - Supply Voltage Maximum Output Voltage - Ambient Temperature Output Source Current - Output Voltage $(RL=10[k\Omega])$ $(VCC=5[V],RL=2[k\Omega])$ (VCC=5[V]) LM2904 family 50 100 30 OUTPUT SOURCE CURRENT [mA] OUTPUT SINK CURRENT [mA] **CUTPUT SINK CURRENT [mA]** 40 10 20 30 15\ 20 0.1 10 10 0 0.001 0 25 50 75 100 125 150 75 100 125 150 0 25 50 0.8 AMBIENT TEMPERATURE [°C] OUTPUT VOLTAGE [V] AMBIENT TEMPERATURE [°C] Fig. 56 Fig. 55 Fig. 57 Output Sink Current - Ambient Temperature Output Source Current - Ambient Temperature Output Sink Current - Output Voltage (VCC=5[V]) (VOUT=VCC) (VOUT=0[V]) LM2904 family LM2904 family LM2904 family 80 80 32\ 70 6 70 LOW LEVEL SINK CURRENT [µA] LOW LEVEL SINK CURRENT [µA] INPUT OFFSET VOLTAGE [mV] 60 60 5\/ 50 50 2 40 40 0 30 30 -2 85°C 20 20 -4 10 10 -6 0 0 5 10 15 20 25 30 25 50 75 100 125 0 15 20 10 25 SUPPLY VOLTAGE [V] AMBIENT TEMPERATURE [°C] SUPPLY VOLTAGE [V] Fig. 59 Fig. 60 Input Offset Voltage - Supply Voltage (Vicm=0[V], VOUT=1.4[V]) Fig. 58 Low Level Sink Current - Ambient Temperature Low Level Sink Current - Supply Voltage (VOUT=0.2[V]) (VOUT=0.2[V])

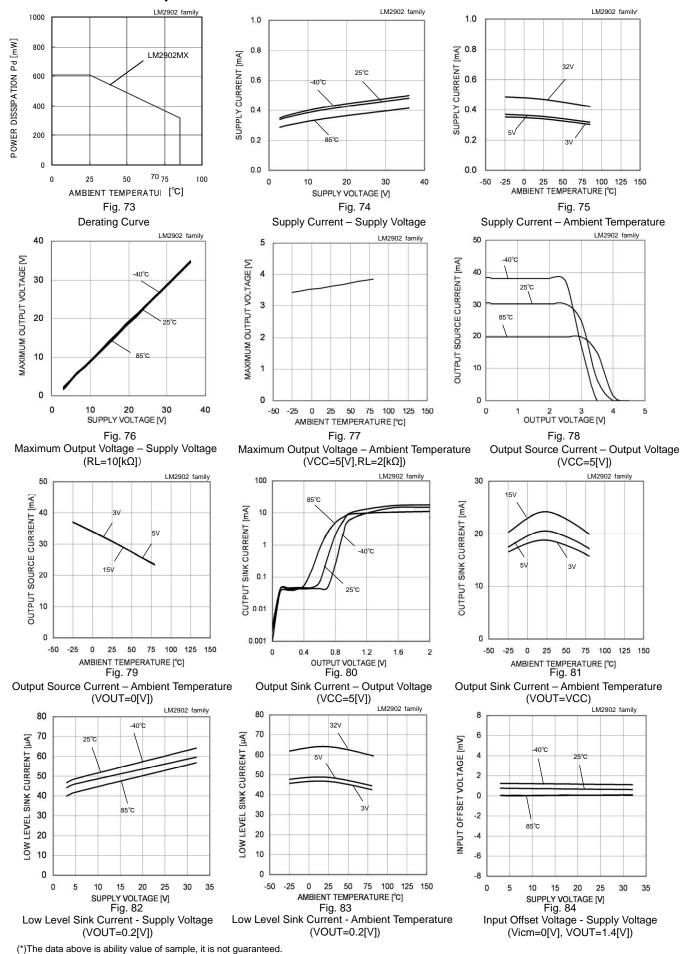
(*)The data above is ability value of sample, it is not guaranteed.

● Reference Data LM2904 family



(*)The data above is ability value of sample, it is not guaranteed.

Reference Data LM2902 family



●Reference DataLM2902 family LM2902 family LM2902 family LM2902 family 50 50 6 INPUT BIAS CURRENT [nA] INPUT BIAS CURRENT [nA] 40 INPUT OFFSET VOLTAGE 3V 32V 2 30 0 20 -2 -4 10 -6 0 -50 50 75 100 125 150 -25 50 75 100 125 150 0 10 15 20 25 SUPPLY VOLTAGE [V] -50 0 25 AMBIENT TEMPERATURE [℃] AMBIENT TEMPERATURE [°C] Fig. 86 Input Bias Current – Supply Voltage Fig. 85 Fig. 87 Input Offset Voltage – Ämbient Temperature Input Bias Current - Ambient Temperature (Vicm=0[V], VOUT=1.4[V]) (Vicm=0[V], VOUT=1.4[V]) (Vicm=0[V], VOUT=1.4[V]) LM2902 family LM2902 family 50 6 INPUT OFFSET CURRENT [nA] INPUT OFFSET VOLTAGE [mV] 85°C INPUT BIAS CURRENT[nA] 25°C 0 0 -2 85°C 0 -6 -10 1 2 3 INPUT VOLTAGE [V] 25 50 75 100 125 150 -50 AMBIENT TEMPERATURE [℃] SUPPLY VOLTAGE [V] Fig. 88 Fig. 90 Fig. 89 Input Offset Voltage - Common Mode Input Voltage Input Bias Current - Ambient Temperature Input Offset Current - Supply Voltage (VCC=30[V],Vicm=28[V],VOUT=1.4[V]) (VCC=5[V]) (Vicm=0[V], VOUT=1.4[V]) LM2902 family LM2902 family 140 140 10 LARGE SIGNAL VOLTAGE GAIN [dB] LARGE SIGNAL VOLTAGE GAIN [dB] LARGE SIGNAL VOLTAGE GAIN [dB] [dB] 25°C INPUT OFFSET CURRENT [nA] 40°C 15V LARGE SIGNAL VOLTAGE GAIN 120 110 0 100 5V 90 32V 85°C 80 70 60 -25 0 25 50 75 100 125 150 AMBIENT TEMPERATURE [°C] -50 -50 -25 0 25 50 75 100 125 150 8 10 12 SUPPLY VOLTAGE [V] AMBIENT TEMPERATURE [℃] Fig. 91 Fig. 92 Fig. 93 Input Offset Current – Ambient Temperature Large Signal Voltage Gain - Supply Voltage Large Signal Voltage Gain (Vicm=0[V], VOUT=1.4[V]) $(RL=2[k\Omega])$ - Ambient Temperature $(RL=2[k\Omega])$ LM2902 family LM2902 family LM2902 family 140 140 COMMON MODE REJECTION RATIO [dB] COMMON MODE REJECTION RATIO [dB] 32\ 130 RATIO 120 120 120 POWER SUPPLY REJECTION 110 100 100 100 80 80 90 85°C 80 60 70 40 -50 0 25 50 75 100 125 150 -50 25 50 75 100 125 150 10 20 30 SUPPLY VOLTAGE [V] AMBIENT TEMPERATURE [°C] AMBIENT TEMPERATURE [°C] Fig. 94 Fig. 95 Fig. 96 Common Mode Rejection Ratio Common Mode Rejection Ratio Power Supply Rejection Ratio - Ambient Temperature

(*)The data above is ability value of sample, it is not guaranteed.

- Supply Voltage

- Ambient Temperature

●Circuit Diagram

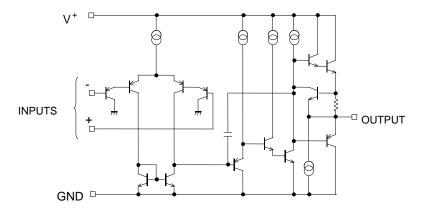


Fig.97 Circuit Diagram (each Op-Amp)

■ Measurement Circuit 1 NULL Method measurement Condition

V⁺, GND, EK, VICR Unit: [V]

Parameter	VF	S1	S1 S2		LM:	358/LN	1324 faı	mily	LM2	904/LM	12902 fa	amily	Calculation			
Parameter	VF	31	32	S3	V+	GND	EK	VICR	V+	GND	EK	VICR	Calculation			
Input Offset Voltage	VF1	ON	ON	OFF	5 to 30	0	-1.4	0	5 to 30	0	-1.4	0	1			
Input Offset Current	VF2	OFF	OFF	OFF	5	0	-1.4	0	5	0	-1.4	0	2			
Input Bias Current	VF3	OFF	ON OFF	5	0	-1.4	0	5	0	-1.4	0	3				
input bias Current	VF4	ON	OFF	OFF	5	0	-1.4	0	5	0	-1.4	0	3			
Large Signal Voltage Gain	VF5	ON	ON	ON	15	0	-1.4	0	15	0	-1.4	0	4			
Large Signal Voltage Gain	VF6	OIN	ON	ON	15	0	-11.4	0	15	0	-11.4	0	4			
Common mode Painstian Patio	VF7	ON	ON	ON	OFF	5	0	-1.4	0	5	0	-1.4	0	5		
Common-mode Rejection Ratio	VF8	ON	ON C	ON	NON	NO NC	OFF	5	0	-1.4	3.5	5	0	-1.4	3.5	3
Dower supply Poinction Potio	VF9	ON	ON	OFF	5	0	-1.4	0	5	0	-1.4	0	6			
Power supply Rejection Ratio	VF10	ON	ON	OFF	30	0	-1.4	0	30	0	-1.4	0	O			

-Calculation-

1.Input Offset Voltage (VIO)

$$Vio = \frac{|VF1|}{1 + Rf/Rs} [V]$$

2.Input Offset Current (IIO)

lio =
$$\frac{|VF2 - VF1|}{Ri(1+ Rf / Rs)}[A]$$

3.Input Bias Current (IIb)

Ib =
$$\frac{|VF4 - VF3|}{2 \times Ri (1 + Rf / Rs)}$$
 [A]

4. Large Signal Voltage Gain (Av)

$$AV = 20 \times Log \frac{10 \times (1 + Rf/Rs)}{|VF6 - VF5|} [dB]$$

5.Common-mode Rejection Ration (CMRR)

CMRR =
$$20 \times \text{Log} \frac{3.5 \times (1 + \text{Rf/ Rs})}{|\text{VF8-VF7}|} [dB]$$

6. Power supply rejection ratio (PSRR)

$$PSRR = 20 \times Log \frac{\Delta V^{+} \times (1 + Rf/Rs)}{VF10 - VF9} [dB]$$

△V+=25V

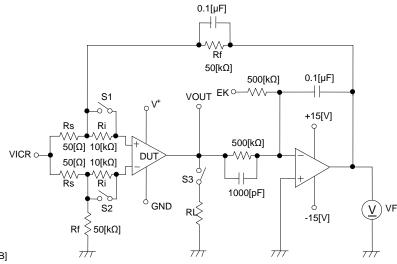
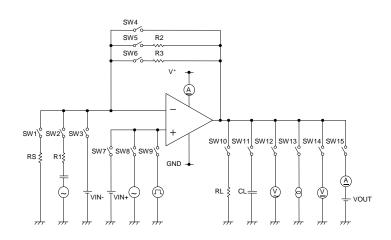


Fig.98 Measurement circuit1 (Each Op Amps)

Measurement Circuit2 Switch Condition

SW No.	SW 1	SW 2	SW 3	SW 4	SW 5	SW 6	SW 7	SW 8	SW 9	SW 10	SW 11	SW 12	SW 13	SW 14	SW 15
Supply Current	OFF	OFF	OFF	ON	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
High Level Output Voltage	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF
Low Level Output Voltage	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF
Output Source Current	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON
Output Sink Current	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON
Slew Rate	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	ON	ON	ON	OFF	OFF	OFF	OFF
Gain Bandwidth Product	OFF	ON	OFF	OFF	OFF	ON	ON	OFF	OFF	ON	ON	OFF	OFF	OFF	OFF
Equivalent Input Noise Voltage	ON	OFF	OFF	OFF	ON	OFF	ON	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF



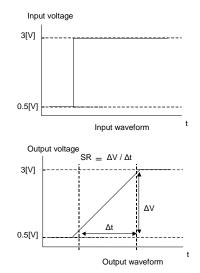


Fig.99 Measurement Circuit2 (each Op-Amp)

Fig.100 Slew Rate Input Waveform

● Measurement Circuit3 Amplifier To Amplifier Coupling

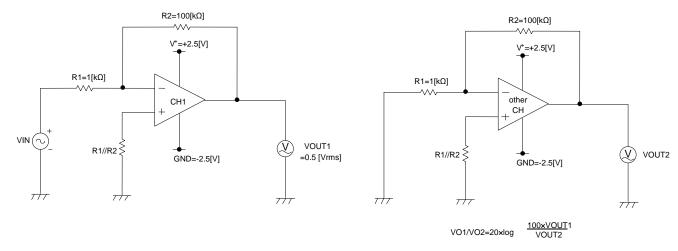


Fig.101 Measurement Circuit3

NOW SERIES LM2904/2902/358/324 family

Description of Electrical Characteristics

Described below are descriptions of the relevant electrical terms

Please note that item names, symbols and their meanings may differ from those on another manufacturer's documents.

1.Absolute maximum ratings

The absolute maximum ratings are values that should never be exceeded, since doing so may result in deterioration of electrical characteristics or damage to the part itself as well as peripheral components.

1.1 Power supply voltage (V*/GND)

Expresses the maximum voltage that can be supplied between the positive and negative supply terminals without causing deterioration of the electrical characteristics or destruction of the internal circuitry.

1.2 Differential input voltage (VID)

Indicates the maximum voltage that can be supplied between the non-inverting and inverting terminals without damaging the IC.

1.3 Input common-mode voltage range (VICR)

Signifies the maximum voltage that can be supplied to non-inverting and inverting terminals without causing deterioration of the characteristics or damage to the IC itself. Normal operation is not guaranteed within the common-mode voltage range of the maximum ratings – use within the input common-mode voltage range of the electric characteristics instead.

1.4 Operating and storage temperature ranges (Topr,Tstg)

The operating temperature range indicates the temperature range within which the IC can operate. The higher the ambient temperature, the lower the power consumption of the IC. The storage temperature range denotes the range of temperatures the IC can be stored under without causing excessive deterioration of the electrical characteristics.

1.5 Power dissipation (Pd)

Indicates the power that can be consumed by a particular mounted board at ambient temperature (25°C). For packaged products, Pd is determined by the maximum junction temperature and the thermal resistance.

2. Electrical characteristics

2.1 Input offset voltage (VIO)

Signifies the voltage difference between the non-inverting and inverting terminals. It can be thought of as the input voltage difference required for setting the output voltage to 0 V.

2.2 Input offset voltage drift ($\triangle VIO/\triangle T$)

Denotes the ratio of the input offset voltage fluctuation to the ambient temperature fluctuation.

2.3 Input offset current (IIO)

Indicates the difference of input bias current between the non-inverting and inverting terminals.

2.4 Input offset current drift (△IIO/△T)

Signifies the ratio of the input offset current fluctuation to the ambient temperature fluctuation.

2.5 Input bias current (IIB)

Denotes the current that flows into or out of the input terminal, it is defined by the average of the input bias current at the non-inverting terminal and the input bias current at the inverting terminal.

2.6 Circuit current (ICC)

Indicates the current of the IC itself that flows under specified conditions and during no-load steady state.

2.7 High level output voltage/low level output voltage (VOH/VOL)

Signifying the voltage range that can be output under specified load conditions, it is in general divided into high level output voltage and low level output voltage. High level output voltage indicates the upper limit of the output voltage, while low level output voltage the lower limit.

2.8 Large signal voltage gain (AV)

The amplifying rate (gain) of the output voltage against the voltage difference between non-inverting and inverting terminals, it is (normally) the amplifying rate (gain) with respect to DC voltage.

AV = (output voltage fluctuation) / (input offset fluctuation)

2.9 Input common-mode voltage range (VICR)

Indicates the input voltage range under which the IC operates normally.

2.10 Common-mode rejection ratio (CMRR)

Signifies the ratio of fluctuation of the input offset voltage when the in-phase input voltage is changed (DC fluctuation).

CMRR = (change in input common-mode voltage) / (input offset fluctuation)

2.11 Power supply rejection ratio (PSRR)

Denotes the ratio of fluctuation of the input offset voltage when supply voltage is changed (DC fluctuation).

SVR = (change in power supply voltage) / (input offset fluctuation)

2.12 Output source current/ output sink current (IOH/IOL)

The maximum current that can be output under specific output conditions, it is divided into output source current and output sink current. The output source current indicates the current flowing out of the IC, and the output sink current the current flowing into the IC.

2.13 Channel separation (CS)

Expresses the amount of fluctuation of the input offset voltage or output voltage with respect to the change in the output voltage of a driven channel.

2.14 Slew rate (SR)

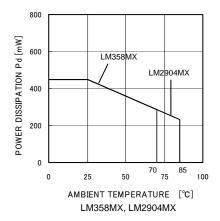
Indicates the time fluctuation ratio of the output voltage when an input step signal is supplied.

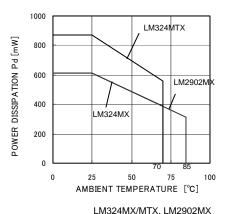
2.15 Gain bandwidth product (GBW)

The product of the specified signal frequency and the gain of the op-amp at such frequency, it gives the approximate value of the frequency where the gain of the op-amp is 1 (maximum frequency, and unity gain frequency).

NOW SERIES LM2904/2902/358/324 family

Derating curves





Power Dissipation

Package	Pd[W]	θ ja [°C/W]
SO package8 (*8)	450	3.6

Power Dissipation

Package	Pd[W]	θ ja [°C/W]
SO package14	610	4.9
TSSOP14	870	7.0

Fig.102 Derating Curves

Precautions

1) Unused circuits

When there are unused circuits, it is recommended that they be connected as in Fig.103, setting the non-inverting input terminal to a potential within the in-phase input voltage range (VICR).

2) Input terminal voltage

Applying GND + 32V to the input terminal is possible without causing deterioration of the electrical characteristics or destruction, irrespective of the supply voltage. However, this does not ensure normal circuit operation.

Please note that the circuit operates normally only when the input voltage is within the common mode input voltage range of the electric characteristics.



The op-amp operates when the voltage supplied is between V* and GND Therefore, the single supply op-mp can be used as a dual supply op-amp as well.

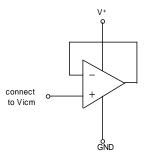


Fig.103 Disable circuit example

4) Power dissipation (Pd)

Using the unit in excess of the rated power dissipation may cause deterioration in electrical characteristics due to the rise in chip temperature, including reduced current capability. Therefore, please take into consideration the power dissipation (Pd) under actual operating conditions and apply a sufficient margin in thermal design. Refer to the thermal derating curves for more information.

5) Short-circuit between pins and erroneous mounting

Incorrect mounting may damage the IC. In addition, the presence of foreign substances between the outputs, the output and the power supply, or the output and GND may result in IC destruction.

6) Operation in a strong electromagnetic field

Operation in a strong electromagnetic field may cause malfunctions.

7) Radiation

This IC is not designed to withstand radiation.

8) IC handing

Applying mechanical stress to the IC by deflecting or bending the board may cause fluctuation of the electrical characteristics due to piezoelectric (piezo) effects

IC operation

The output stage of the IC is configured using Class C push-pull circuits. Therefore, when the load resistor is connected to the middle potential of V^* and GND, crossover distortion occurs at the changeover between discharging and charging of the output current. Connecting a resistor between the output terminal and GND, and increasing the bias current for Class A operation will suppress crossover distortion.

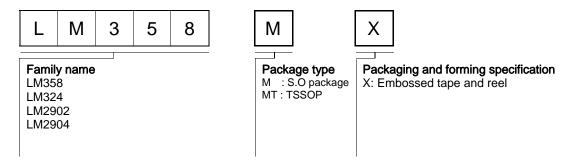
10) Board inspection

Connecting a capacitor to a pin with low impedance may stress the IC. Therefore, discharging the capacitor after every process is recommended. In addition, when attaching and detaching the jig during the inspection phase, ensure that the power is turned OFF before inspection and removal. Furthermore, please take measures against ESD in the assembly process as well as during transportation and storage.

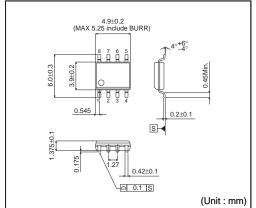
11) Output capacitor

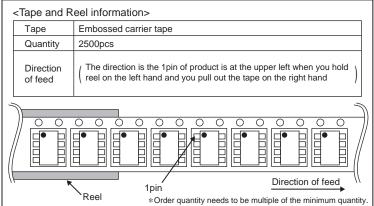
Discharge of the external output capacitor to V^+ is possible via internal parasitic elements when V^+ is shorted to GND, causing damage to the internal circuitry due to thermal stress. Therefore, when using this IC in circuits where oscillation due to output capacitive load does not occur, such as in voltage comparators, use an output capacitor with a capacitance less than $0.1 \,\mu$ F.

Ordering part number

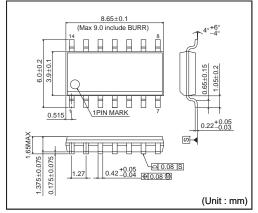


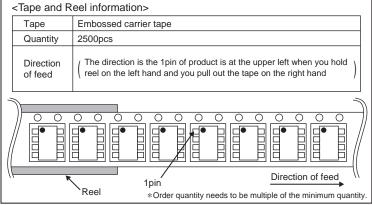
S.O package8



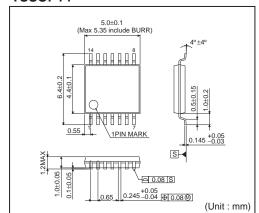


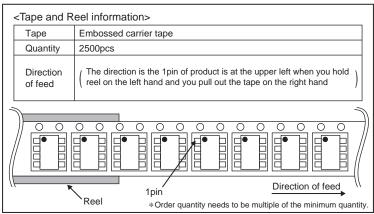
S.O package14





TSSOP14





Notice

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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCTI	CLASS II b	СГУССШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

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